



1105-02

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Atty. Docket No.: BUR920010071US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Response Transmittal

In re application of: Bryant, et al.

Serial No.: 09/682,957

Filed: 11/02/2001

For: TRANSISTOR STRUCTURE WITH THICK RECESSED
SOURCE/DRAIN STRUCTURES AND FABRICATION
PROCESS OF SAME

Box No Fee

Commissioner of Patents and Trademarks

Washington, D.C. 20231

Sir:

Transmitted herewith for filing in the above-identified Application is a:

1. Response/Election

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(Col. 3)

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Date: October 21, 2002

Respectfully submitted,

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I hereby certify that this paper is being facsimile transmitted to the Patent and Trademark Office on the date shown below.

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Heather Clark
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